


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	AMS/19/11352	
1.3 Title of PCN	Transfer to ST Bouskoura as new Assembly and TnF site and change of MSL for selected products in SO14 Package. (Line: D350-U333-U367-UE35-UE29).	
1.4 Product Category	See Products List	
1.5 Issue date	2019-02-01	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	FRANK SCHIFANO
2.1.2 Phone	+1 5148333778
2.1.3 Email	frank.schifano@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Domenico ARRIGO
2.1.2 Marketing Manager	Fulvio PULICELLI
2.1.3 Quality Manager	Alessandro PLATINI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Product transfer from one site to another site, even if test or process line is qualified	BOUSKOURA

4. Description of change

	Old	New
4.1 Description	-SHENZHEN as Assembly and TnF plant. -MSL1	-BOUSKOURA as Assembly and TnF plant. -MSL3
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	The transfer from Shenzhen to Bouskoura and the change of MLS, for the selected products in SO14 package, allows the rationalization of the manufacturing and better supports the customers demand.
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	New FGs code
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7. Timing / schedule

7.1 Date of qualification results	2019-03-31
7.2 Intended start of delivery	2019-05-04
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	
8.2 Qualification report and qualification results	In progress
	Issue Date

9. Attachments (additional documentations)

11352 Public product.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L6386ED	

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